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16-CHANNEL (4 BANKS OF 4-CHANNEL) HIGH-VOLTAGE ANALOG SWITCH

© ABLIC Inc., 2017-2021 Rev.2.0_00

The ABLIC Inc. HDL6M06502B is 16-channel high-voltage analog switch IC operated only by a single 5V for ultrasound imaging applications.

The HDL6M06502B consists of 4 sets of 4 single-pole, single-throw (SPST) analog switches controlled by 4 logic inputs. The HDL6M06502B has a unique pin-out which makes PCB traces easier.

Functions

• 16-channel (4 banks of 4-channel) high-voltage SPST analog switch with active ground clamp

Features

- 0V to ±100V analog signal voltage range (10kHz to 20MHz signal frequency range)
- 2A peak analog signal current per channel
- 8Ω main switch on-resistance
- 40kΩ bleed resistor on probe side
- Low on/off-capacitance
- -52dB off-isolation at 5MHz (load-independent)
- -60dB switch crosstalk
- 20Ω ground clamp switch on probe side alternately turned on/off with main switch
- DS_ASW to disable 20Ω ground clamp switch
- 1.8V to 5V CMOS logic interface
- Single +5V power supply (NO HIGH-VOLTAGE POWER SUPPLY required)
- Low power dissipation (static 1mW)
- Unique pin configuration for easy PCB traces (SPs on one side and STs on opposite side)
- 52-lead 8x8mm QFN package (RoHS compliant)

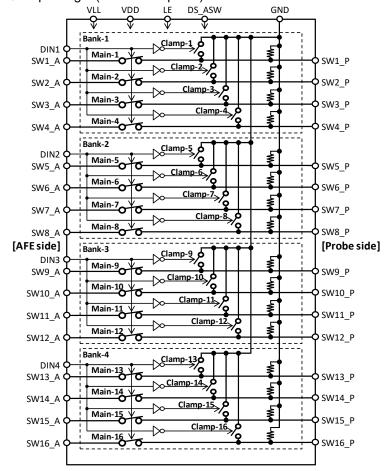


Fig.1 Block diagram ABLIC Inc.

1. Absolute Maximum Ratings

T_A=25°C unless otherwise noted.

Table 1 Absolute Maximum Ratings

No.	Items	Symbol	Value	Units	Condition
1	Positive logic supply voltage	V _{LL}	-0.4 to +7	V	
2	Positive supply voltage	V_{DD}	-0.4 to +7	V	
3	Logic input voltage (x=1~4)	DINx, LE, DS_ASW	-0.4 to +7	V	
4	Analog signal range	VsiG	-105 to +105	V	
5	Peak analog signal current per channel	Isw	2.5	Α	
6	Operating junction temperature	TJop	-20 to +150	°C	
7	Storage temperature	T _{STG}	-55 to +150	°C	
8	Maximum power dissipation	P _{Dmax}	4	W	

NOTE: * Stresses beyond the absolute maximum ratings may cause permanent damage to the product.

2. Operating Supply Voltages, Logic Inputs, and Application Circuits

2.1 Operating Supply Voltages, Temperature, and Logic Inputs

Table 2 Operating Supply Voltages and Logic Inputs

No	Items	Symbol	Min	Тур	Max	Units	Condition
1	Logic supply voltage	V_{LL}	1.7	1.8 to 5	V_{DD}	V	
2	Positive supply voltage	V_{DD}	4.75	5	5.25	V	
3	IC substrate voltage *1	VsuB	-	0	-	V	
4	Operating free-air temperature	TA	0		75	°C	
5	High-level logic input voltage	VIH	0.8V _{LL}	-	V_{LL}	V	
6	Low-level logic input voltage	VIL	0	-	0.2V _{LL}	V	
7	Logic input high current *2	Іін	-10	-	10	μA	
8	Logic input low current	lıL	-10	-	10	μA	DINx (x=1~4), LE, DS ASW
9	Logic input capacitance	Cin	-	2	-	pF	IBO_AOW
10	Setup time	tsu	20	-	-	ns	
11	Hold time	t _{HLD}	20	-	-	ns	
12	LE time width	t _{LEW}	20	-	-	ns	

NOTE:

2

2.2 Power Supply Sequencing

No power supply sequencing is required even if V_{LL} is different from V_{DD} . Please apply the V_{DD} voltage to the V_{LL} when operating with a single 5V.

^{*1)} Thermal pad on the bottom of the package must be soldered to the ground.

^{*2)} DS_ASW has $100\mu A$ leakage at V_{LL} =5V due to $50k\Omega$ internal pull-down resistor.

2.3 Application Circuits

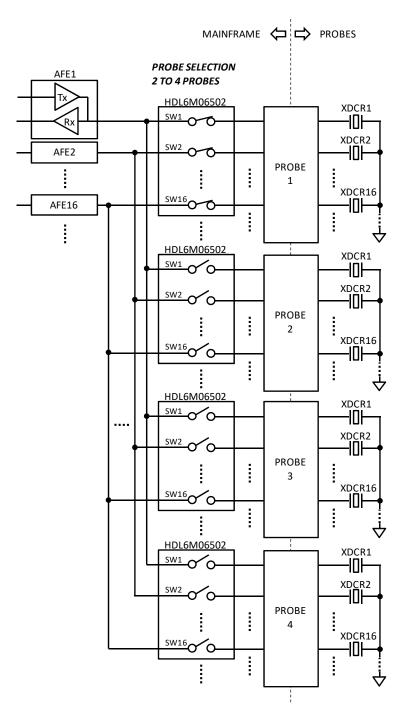


Fig.2 Probe selection (2 to 4 probes) in ultrasound imaging application

3. Electrical Characteristics

DC Characteristics

Table 3 DC Characteristics

 $V_{LL} = 3.3 V, \ V_{DD} = 5 V, \ LE = 0, \ DS_ASW = 0, \ T_A = 25 ^{\circ}C, \ unless \ otherwise \ specified.$

NI-	14	0		Spec		1.1	Conditions	
No.	Items	Symbol	Min	Тур	Max	Units		
1	Analog signal range	VsiG	-100	-	+100	V		
2	V _{LL} quiescent current	ILLQ	-	0.1	-	μΑ	Quiescent current-1	
3	VDD quiescent current	Iddq	ı	250	-	μΑ	All main switches off	
4	V _{LL} quiescent current	ILLQ	ı	0.1	-	μΑ	Quiescent current-2	
5	V _{DD} quiescent current	I _{DDQ}	ı	250	-	μΑ	All main switches on	
6	V _{LL} dynamic current	ILL	ı	0.4	1	μΑ	Dynamic current	
7	V _{DD} dynamic current	I _{DD}	-	1.6	2	mA	All channels switching simultaneously at f _{SW} =50kHz	
8	DC offset main switch off	Vos	-	0	-	mV		
9	Small signal main switch on-resistance	Rons	-	8	10	Ω	V_{SIG} =0.1 V pp to 5 V pp @5 M Hz, R_{S} =10 Ω	
10	Small signal main switch on-resistance matching	ΔRons	-	2	5	%	V _{SIG} =0V, I _{SIG} =5mA	
11	Large signal main switch on-resistance	Ronl	-	8	-	Ω	Vsig=20Vpp@5MHz, Rs=10Ω	
12	GND clamp on-resistance	Roncl	-	20	-	Ω	Main switches off, probe side	
13	Shunt resistance	R _{BLD}	30	40	50	kΩ	Probe side	
14	Switch output peak current	Isw	-	2	-	Α	100ns pulse, 0.1% duty cycle	

AC Characteristics

Table 4 AC Characteristics

 V_{LL} =3.3V, V_{DD} =5V, LE=0, DS_ASW=0, T_A =25°C, unless otherwise specified.

No	Itoma	Cumbal		Spec		1.1	0 4:4:	
No.	Items	Symbol	Min	Тур	Max	Units	Conditions	
_	T	ton	-	2	5	μs		
1	Turn-on time	ton_asw	-	2	5	μs		
	T # #:	toff	-	2	5	μs		
2	Turn-off time	toff_asw	-	2	5	μs		
3	Output switching frequency	fsw	-	-	50	kHz	Duty cycle=50%	
4	Small signal frequency	fsig	0.01	-	20	MHz	C _L =220pF	
_	Off in alation	Mara	-	-49	-	dB	$f_{SIG}=5MHz, R_L//C_L=1k\Omega//15pF$	
5	Off isolation	Viso	-	-52	-	dB	f_{SIG} =5MHz, R_L =50 Ω	
6	Crosstalk	Vст	-	-60	-	dB	f_{SIG} =5MHz, R_L =50 Ω	
7	Off capacitance to GND	Coff	-	30	-	pF	V _{SIG} =0V, f _{SIG} =1MHz	
8	On capacitance to GND	Con	-	15	-	pF	V _{SIG} =0V, f _{SIG} =1MHz	
9	Output spike voltage	Vspk	-10	90	150	mV	50Ω load	

4. Logic Timing

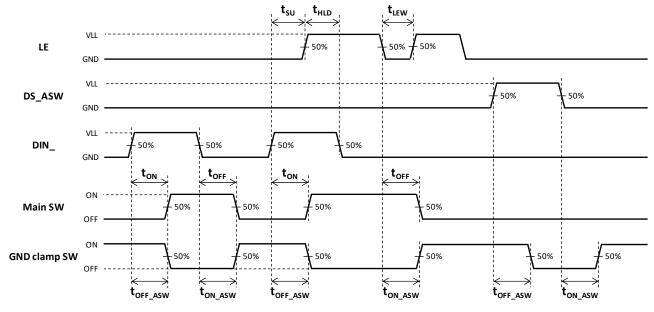


Fig.3 Logic Timing

5. Test Circuits

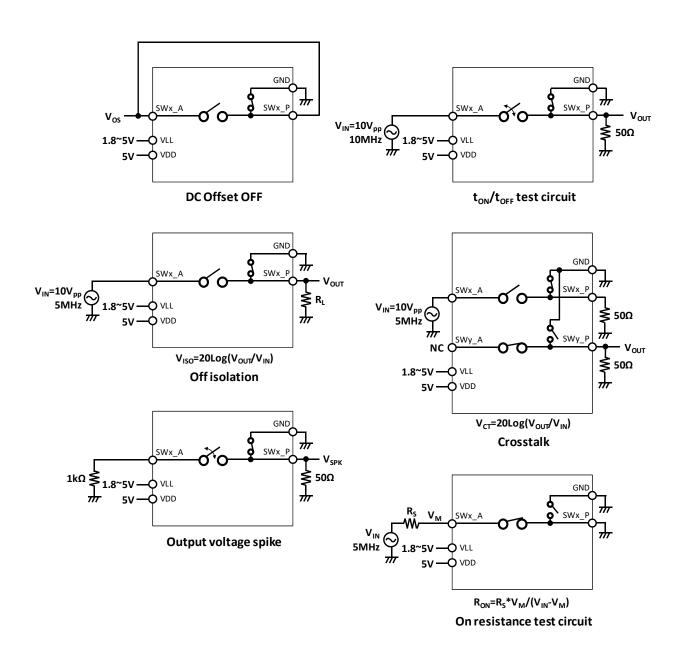


Fig.4 Test Circuits

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6. Truth Table

Table 5 Truth table

Logic Inputs						Analog Switch State								
LE	DS ASW	DIN4	DIN3	DIN2	DIN1	SW13 t	to SW16	SW9 to	SW12	SW5 t	o SW8	SW11	to SW4	
LE	DS_ASW	DIN4	DINO	DINZ	DINT	Main SW	Clamp SW	Main SW	Clamp SW	Main SW	Clamp SW	Main SW	Clamp SW	
0	0	0	0	0	0	OFF	ON	OFF	ON	OFF	ON	OFF	ON	
0	0	0	0	0	1	OFF	ON	OFF	ON	OFF	ON	ON	OFF	
0	0	0	0	1	0	OFF	ON	OFF	ON	ON	OFF	OFF	ON	
0	0	0	0	1	1	OFF	ON	OFF	ON	ON	OFF	ON	OFF	
0	0	0	1	0	0	OFF	ON	ON	OFF	OFF	ON	OFF	ON	
0	0	0	1	0	1	OFF	ON	ON	OFF	OFF	ON	ON	OFF	
0	0	0	1	1	0	OFF	ON	ON	OFF	ON	OFF	OFF	ON	
0	0	0	1	1	1	OFF	ON	ON	OFF	ON	OFF	ON	OFF	
0	0	1	0	0	0	ON	OFF	OFF	ON	OFF	ON	OFF	ON	
0	0	1	0	0	1	ON	OFF	OFF	ON	OFF	ON	ON	OFF	
0	0	1	0	1	0	ON	OFF	OFF	ON	ON	OFF	OFF	ON	
0	0	1	0	1	1	ON	OFF	OFF	ON	ON	OFF	ON	OFF	
0	0	1	1	0	0	ON	OFF	ON	OFF	OFF	ON	OFF	ON	
0	0	1	1	0	1	ON	OFF	ON	OFF	OFF	ON	ON	OFF	
0	0	1	1	1	0	ON	OFF	ON	OFF	ON	OFF	OFF	ON	
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0	1	0	1	0	0	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	
0	1	0	1	0	1	OFF	OFF	ON	OFF	OFF	OFF	ON	OFF	
0	1	0	1	1	0	OFF	OFF	ON	OFF	ON	OFF	OFF	OFF	
0	1	0	1	1	1	OFF	OFF	ON	OFF	ON	OFF	ON	OFF	
0	1	1	0	0	0	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	
0	1	1	0	0	1	ON	OFF	OFF	OFF	OFF	OFF	ON	OFF	
0	1	1	0	1	0	ON	OFF	OFF	OFF	ON	OFF	OFF	OFF	
0	1	1	0	1	1	ON	OFF	OFF	OFF	ON	OFF	ON	OFF	
0	1	1	1	0	0	ON	OFF	ON	OFF	OFF	OFF	OFF	OFF	
0	1	1	1	0	1	ON	OFF	ON	OFF	OFF	OFF	ON	OFF	
0	1	1	1	1	0	ON	OFF	ON	OFF	ON	OFF	OFF	OFF	
0	1	1	1	1	1	ON	OFF	ON	OFF	ON	OFF	ON	OFF	
1	Х	Х	Х	Х	Х				Hold Prev	ious State				

7. Pin Configuration

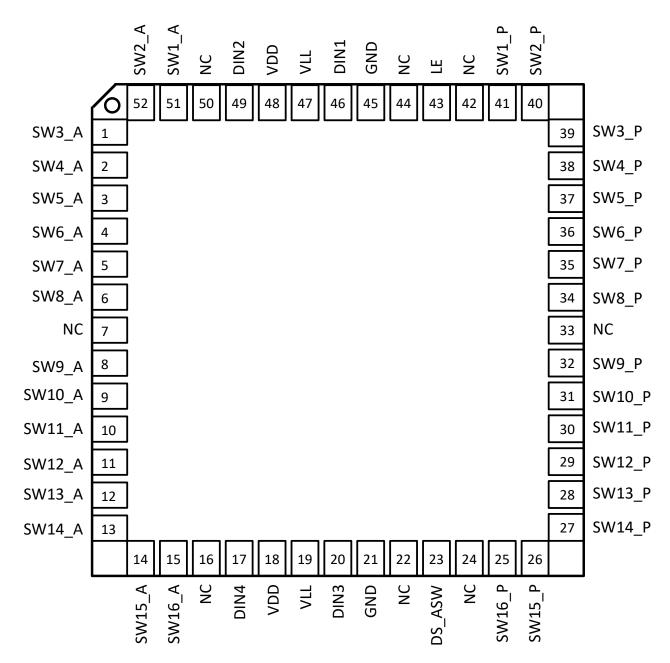


Fig.5 Pin Configuration

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8

Table 6 Pin Configuration

Pin#	Pin Name	I/O	Function
1	SW3_A	I/O	Analog switch terminal 3 (AFE side)
2	SW4_A	I/O	Analog switch terminal 4 (AFE side)
3	SW5_A	I/O	Analog switch terminal 5 (AFE side)
4	SW6_A	I/O	Analog switch terminal 6 (AFE side)
5	SW7_A	I/O	Analog switch terminal 7 (AFE side)
6	SW8_A	I/O	Analog switch terminal 8 (AFE side)
7	NC	-	No connection (Not internally connected)
8	SW9_A	I/O	Analog switch terminal 9 (AFE side)
9	SW10_A	I/O	Analog switch terminal 10 (AFE side)
10	SW11_A	I/O	Analog switch terminal 11 (AFE side)
11	SW12_A	I/O	Analog switch terminal 12 (AFE side)
12	SW13_A	I/O	Analog switch terminal 13 (AFE side)
13	SW14_A	I/O	Analog switch terminal 14 (AFE side)
14	SW15_A	I/O	Analog switch terminal 15 (AFE side)
15	SW16_A	I/O	Analog switch terminal 16 (AFE side)
16	NC	-	No connection (Not internally connected)
17	DIN4	I	Data input 4 for SW13 to SW16, Hi=ON, Low=OFF
18	VDD	-	Positive low voltage power supply (+5V)
19	VLL	-	Positive voltage supply of low voltage interface (+1.8V~+5V)
20	DIN3	I	Data input 3 for SW9 to SW12, Hi=ON, Low=OFF
21	GND	-	Drive power ground (0V)
22	NC	-	No connection (Not internally connected)
23	DS_ASW	I	GND clamp control, Hi=always disabled, Low=main switches and GND clamp switches are alternately turned on and off
24	NC	-	No connection (Not internally connected)
25	SW16_P	I/O	Analog switch terminal 16 (Probe side)
26	SW15_P	I/O	Analog switch terminal 15 (Probe side)

Table 6 Pin Configuration (cont.)

Pin#	Pin Name	I/O	Function
27	SW14_P	I/O	Analog switch terminal 14 (Probe side)
28	SW13_P	I/O	Analog switch terminal 13 (Probe side)
29	SW12_P	I/O	Analog switch terminal 12 (Probe side)
30	SW11_P	I/O	Analog switch terminal 11 (Probe side)
31	SW10_P	I/O	Analog switch terminal 10 (Probe side)
32	SW9_P	I/O	Analog switch terminal 9 (Probe side)
33	NC	-	No connection (Not internally connected)
34	SW8_P	I/O	Analog switch terminal 8 (Probe side)
35	SW7_P	I/O	Analog switch terminal 7 (Probe side)
36	SW6_P	I/O	Analog switch terminal 6 (Probe side)
37	SW5_P	I/O	Analog switch terminal 5 (Probe side)
38	SW4_P	I/O	Analog switch terminal 4 (Probe side)
39	SW3_P	I/O	Analog switch terminal 3 (Probe side)
40	SW2_P	I/O	Analog switch terminal 2 (Probe side)
41	SW1_P	I/O	Analog switch terminal 1 (Probe side)
42	NC	-	No connection (Not internally connected)
43	LE	I	Latch enable input, Hi=Hold data, Low=Latch data input
44	NC	-	No connection (Not internally connected)
45	GND	-	Drive power ground (0V)
46	DIN1	I	Data input 1 for SW1 to SW4, Hi=ON, Low=OFF
47	VLL	-	Positive voltage supply of low voltage interface (+1.8V~+5V)
48	VDD	-	Positive low voltage power supply (+5V)
49	DIN2	I	Data input 2 for SW5 to SW8, Hi=ON, Low=OFF
50	NC	-	No connection (Not internally connected)
51	SW1_A	I/O	Analog switch terminal 1 (AFE side)
52	SW2_A	I/O	Analog switch terminal 2 (AFE side)

8. Package Outline

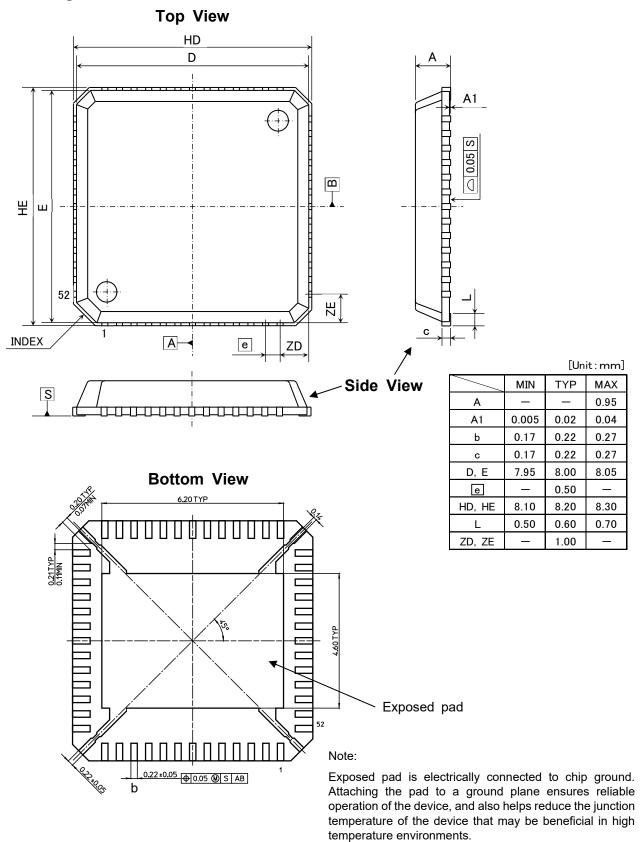
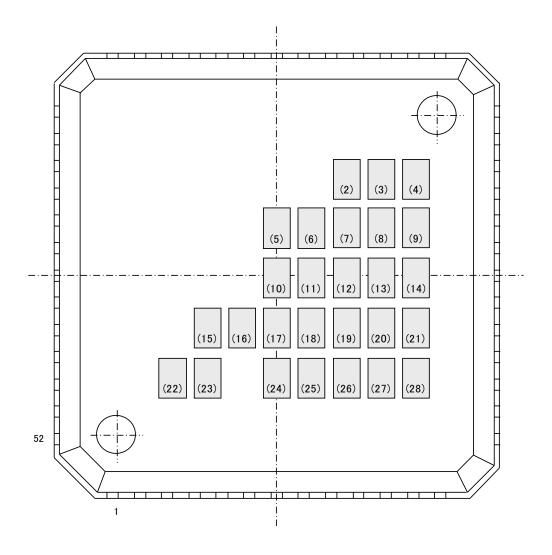


Fig.6 Package Outline (52-Lead QFN Package)

9. Package Marking



No.	Code
(2)	Year sealed : the last one digit of the year
(3)	Month sealed : A~M (exc. " I ") in the order of Jan. to Dec.
(4)	Week sealed : 1~5
(5)~(9)	HDL6M
(10)~(14)	6502B (product name)
(15)~(23)	Quality control code
(24)~(28)	Country of origin

Fig.7 Package Marking

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10. Transport Media, Quantity 322.60 DATE MARKS Tray index 16-NO HOLES Unit: mm 25.40 Fig.8 IC Tray Outline 1. Max 250 IC/Tray 2. 16 positions without holes (*) 3. PPE containing carbon and static proof Max 250 ICs/Tray 4. Heat proof: 130°C, 24hr Empty tray on the top Tray = Max 250 ICs/Box Label A Information Product name HDL6M06502B YMW code Y: Year sealed: The last one digit of the year Humidity Indicator Card P-P Bands M: Month sealed: A~M (exc. " I ") in the order of Jan. to Dec. W: Week sealed : 1~5 Max 250 ICs/Box Label A Solid Desiccant S Quantity Label B Information Dry Pack. QTY LOT CODE Inner Box (Cardboard Paper)

Fig.9 Transport Media, Quantity

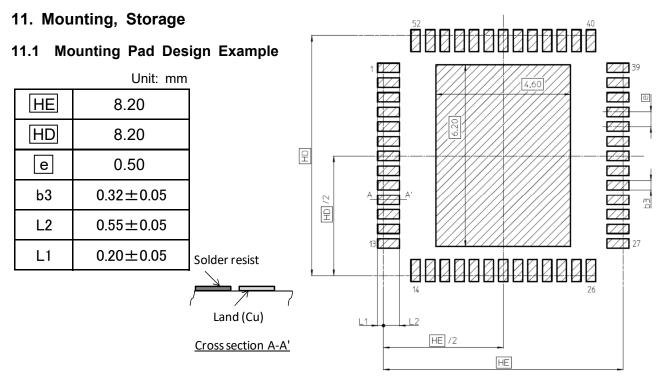


Fig.10 Mounting Pad Design Example

11.2 Storage Conditions

- 11.2.1 The storage location should be kept at 5 to 35 °C and 40 to 70% relative humidity. Keeping in a dry box is recommended. Moisture-proof property is assured for 12 months from delivery date for sealed moisture-proof packing, while it is guaranteed for 7 days from unpacked date under the condition above.
- 11.2.2 When the storage conditions do not conform to those above or other conditions occur indicating moisture exposure, the ICs should be dried to avoid package cracks. A baking process at 125 °C lasting for 24 hours results in sufficient dehumidification. The baking is not allowed more than twice, and the ICs should be mounted within 7 days after initial baking or within 10 days of total exposure after the second dehumidification.

11.3 Reflow Conditions

Typical full heating methods such as Infrared (IR), Hot air, and N2 reflow process are applicable. IR/Air reflow heating conditions are shown below.

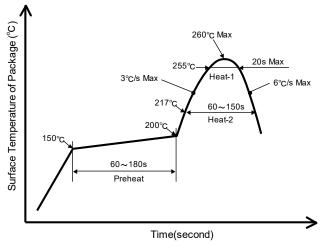


Fig.11 IR/Air Reflow Heating Conditions

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12. Inspection

Hundred percent inspections shall be conducted on electrical characteristics.

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- 14.1 Customers are advised to follow the cautions below to protect products from damage caused by electrical static discharge (ESD).
 - 14.1.1 Material of container or any device to carry products should be free from ESD, which may be caused by vibration while transportation. It is recommended that electric-conductive container or aluminum sheet be used as an effective countermeasure.
 - 14.1.2 Those what touch products such as work platform, machine, measurement/test equipment should be grounded.
 - 14.1.3 Those who deal with products should be grounded through a large series impedance around $100k\Omega$ to $1M\Omega$.
 - 14.1.4 Prevent friction with other materials made with high polymer.
 - 14.1.5 Prevent vibration or friction when carrying the printed circuit board (PCB) where products are mounted. To short circuit terminals is a recommended countermeasure to keep the same electric potential on the PCB.
 - 14.1.6 Avoid dealing with or storing products in an extremely arid environment.
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 - The entire system in which the products are used must be sufficiently evaluated and judged whether the products are allowed to apply for the system on customer's own responsibility.
- 10. The products are not designed to be radiation-proof. The necessary radiation measures should be taken in the product design by the customer depending on the intended use.
- 11. The products do not affect human health under normal use. However, they contain chemical substances and heavy metals and should therefore not be put in the mouth. The fracture surfaces of wafers and chips may be sharp. Be careful when handling these with the bare hands to prevent injuries, etc.
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